PATENT Parent REEL: 013662 FRAME: 0899

Attorney Docket: 32307-181671 Page 2.

146

Name and address of receiving party(ies)

Name: Tokyo Institute of Technology

Internal Address:

Street Address: 2-12-1, Ookayama, Meguro-ku

City: Tokyo Country: Japan

Zip: 152-8550

Name and address of receiving party(ies)

Name: Fuji Electric Corporate Research and Development

Internal Address:

Street Address: 2-2-1, Nagasaka, Yokosuka-shi

City: Kanagawa Country: Japan

Zip: 240-0194

PATENT REEL: 013662 FRAME: 0900

Attorney Docket:: 32307-181671

## ASSIGNMENT OF APPLICATION FOR UNITED STATES PATENT

Hideomi KOINUMA; Masashi KAWASAKI; Toyohiro CHIKYOW; Yoshiyuki YONEZAWA; Whereas Yoshinori KONISHI of Tokyo, Kanagawa, Ibaraki, Kanagawa, and Kanagawa, Japan respectively hereinafter (collectively) referred to as the assignor, have invented a certain improvement relating to COMPOSITE INTEGRATED CIRCUIT AND ITS FABRICATION METHOD for which said assignor has caused an application for a United States Patent to be prepared.

said application having been filed in the U.S. Patent and Trademark Office on June 11, 2002 and given Application No. 10/166,055;

AND WHEREAS

National Institute for Materials Science 1-2-1, Sengen, Tsukuba-shi, Ibaraki 305-0047, Japan

and

Tokyo Institute of Technology 2-12-1, Ookayama, Meguro-ku, Tokyo 152-8550, Japan

and

Fuji Electric Corporate Research and Development, Ltd. 2-2-1, Nagasaka, Yokosuka-shi, Kanagawa 240-0194, Japan

hereinafter referred to as the assignee, is desirous of acquiring collectively the entire right, title and interest in and to said application, including any divisions and continuations thereof, and in and to said invention and any patents which may be granted therefor, including any renewals, reissues and prolongations thereof. The assigned interests are to be divided as follows: National Institute for Materials Science is to be assigned 20% of the undivided interest; Tokyo Institute of Technology is to be assigned 40% of the undivided interest; and Fuji Electric Corporate Research and Development Ltd. is to be assigned 40% of the undivided interest.

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the entire and exclusive right, title and interest in and to said invention and to said application, including any divisions and continuations thereof, and in any patents which may be granted therefor, including any renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said invention and said application, including any divisions and continuations thereof, and any patents which may be granted therefor, including any renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any such patents when granted, including any renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any acts relating to the obtaining or to the asserting of said patents, including any renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue a Patent on said application, and on any divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

EXECUTED this day, Dct. 21, 2002,

ASSIGNOR: Signature:

Name:

Hideomi KOINUMA

PATENT REEL: 013662 FRAME: 0901

Attorney Docket: 32307-181671

Page 2 of 2

## ASSIGNMENT OF APPLICATION FOR UNITED STATES PATENT

Title: COMPOSITE INTEGRATED CIRCUIT AND ITS FABRICATION METHOD

EXECUTED this day, (Closer 31, 2002,

EXECUTED this day, November, 5, 2002,

ASSIGNOR:
Signature:
Name:
Toyohiro CHIKYOW

EXECUTED this day, November 6 2002,

ASSIGNOR: Signature: 4/0/3

EXECUTED this day, October 22, 2002,
ASSIGNOR: Yoshinovi Kohishi

Signature:\_\_

**RECORDED: 01/14/2003** 

-2-